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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "**Embedded - Microcontrollers**"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	2KB (2K x 8)
Program Memory Type	FLASH
EEPROM Size	64 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f021apj020sg

Internal Precision Oscillator

The internal precision oscillator (IPO) is a trimmable clock source that requires no external components.

Temperature Sensor

The optional temperature sensor produces an analog output proportional to the device temperature. This signal can be sent to either the ADC or the analog comparator.

Analog Comparator

The analog comparator compares the signal at an input pin with either an internal programmable voltage reference or a second input pin. The comparator output can be used to drive either an output pin or to generate an interrupt.

External Crystal Oscillator

The crystal oscillator circuit provides highly accurate clock frequencies with the use of an external crystal, ceramic resonator or RC network.

Low Voltage Detector

The low voltage detector (LVD) is able to generate an interrupt when the supply voltage drops below a user-programmable level. The LVD is available on 8-pin devices only.

On-Chip Debugger

The Z8 Encore! XP F082A Series products feature an integrated on-chip debugger (OCD) accessed via a single-pin interface. The OCD provides a rich-set of debugging capabilities, such as reading and writing registers, programming Flash memory, setting breakpoints and executing code.

Universal Asynchronous Receiver/Transmitter

The full-duplex universal asynchronous receiver/transmitter (UART) is included in all Z8 Encore! XP package types. The UART supports 8- and 9-bit data modes and selectable parity. The UART also supports multi-drop address processing in hardware. The UART baud rate generator (BRG) can be configured and used as a basic 16-bit timer.

Timers

Two enhanced 16-bit reloadable timers can be used for timing/counting events or for motor control operations. These timers provide a 16-bit programmable reload counter and

General-Purpose Input/Output

The Z8 Encore! XP F082A Series products support a maximum of 25 port pins (Ports A–D) for general-purpose input/output (GPIO) operations. Each port contains control and data registers. The GPIO control registers determine data direction, open-drain, output drive current, programmable pull-ups, Stop Mode Recovery functionality and alternate pin functions. Each port pin is individually programmable. In addition, the Port C pins are capable of direct LED drive at programmable drive strengths.

GPIO Port Availability By Device

Table 14 lists the port pins available with each device and package type.

Table 14. Port Availability by Device and Package Type

Devices	Package	ADC	Port A	Port B	Port C	Port D	Total I/O
Z8F082ASB, Z8F082APB, Z8F082AQB Z8F042ASB, Z8F042APB, Z8F042AQB Z8F022ASB, Z8F022APB, Z8F022AQB Z8F012ASB, Z8F012APB, Z8F012AQB	8-pin	Yes	[5:0]	No	No	No	6
Z8F081ASB, Z8F081APB, Z8F081AQB Z8F041ASB, Z8F041APB, Z8F041AQB Z8F021ASB, Z8F021APB, Z8F021AQB Z8F011ASB, Z8F011APB, Z8F011AQB	8-pin	No	[5:0]	No	No	No	6
Z8F082APH, Z8F082AHH, Z8F082ASH Z8F042APH, Z8F042AHH, Z8F042ASH Z8F022APH, Z8F022AHH, Z8F022ASH Z8F012APH, Z8F012AHH, Z8F012ASH	20-pin	Yes	[7:0]	[3:0]	[3:0]	[0]	17
Z8F081APH, Z8F081AHH, Z8F081ASH Z8F041APH, Z8F041AHH, Z8F041ASH Z8F021APH, Z8F021AHH, Z8F021ASH Z8F011APH, Z8F011AHH, Z8F011ASH	20-pin	No	[7:0]	[3:0]	[3:0]	[0]	17
Z8F082APJ, Z8F082ASJ, Z8F082AHJ Z8F042APJ, Z8F042ASJ, Z8F042AHJ Z8F022APJ, Z8F022ASJ, Z8F022AHJ Z8F012APJ, Z8F012ASJ, Z8F012AHJ	28-pin	Yes	[7:0]	[5:0]	[7:0]	[0]	23
Z8F081APJ, Z8F081ASJ, Z8F081AHJ Z8F041APJ, Z8F041ASJ, Z8F041AHJ Z8F021APJ, Z8F021ASJ, Z8F021AHJ Z8F011APJ, Z8F011ASJ, Z8F011AHJ	28-pin	No	[7:0]	[7:0]	[7:0]	[0]	25

it is appropriate to have the Timer Output make a state change at a One-Shot time-out (rather than a single cycle pulse), first set the TPOL bit in the Timer Control Register to the start value before enabling ONE-SHOT Mode. After starting the timer, set TPOL to the opposite bit value.

Observe the following steps for configuring a timer for ONE-SHOT Mode and initiating the count:

1. Write to the Timer Control Register to:
   – Disable the timer
   – Configure the timer for ONE-SHOT Mode.
   – Set the prescale value.
   – Set the initial output level (High or Low) if using the Timer Output alternate function.

2. Write to the Timer High and Low Byte registers to set the starting count value.

3. Write to the Timer Reload High and Low Byte registers to set the reload value.

4. If appropriate, enable the timer interrupt and set the timer interrupt priority by writing to the relevant interrupt registers.

5. If using the Timer Output function, configure the associated GPIO port pin for the Timer Output alternate function.

6. Write to the Timer Control Register to enable the timer and initiate counting.

In ONE-SHOT Mode, the system clock always provides the timer input. The timer period is computed via the following equation:

$$\text{ONE-SHOT Mode Time-Out Period (s)} = \frac{\text{Reload Value} - \text{Start Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

CONTINUOUS Mode

In CONTINUOUS Mode, the timer counts up to the 16-bit reload value stored in the Timer Reload High and Low Byte registers. The timer input is the system clock. Upon reaching the reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes. Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state (from Low to High or from High to Low) at timer Reload.

Observe the following steps for configuring a timer for CONTINUOUS Mode and initiating the count:

1. Write to the Timer Control Register to:
   – Disable the timer
   – Configure the timer for CONTINUOUS Mode

Figure 10. UART Block Diagram

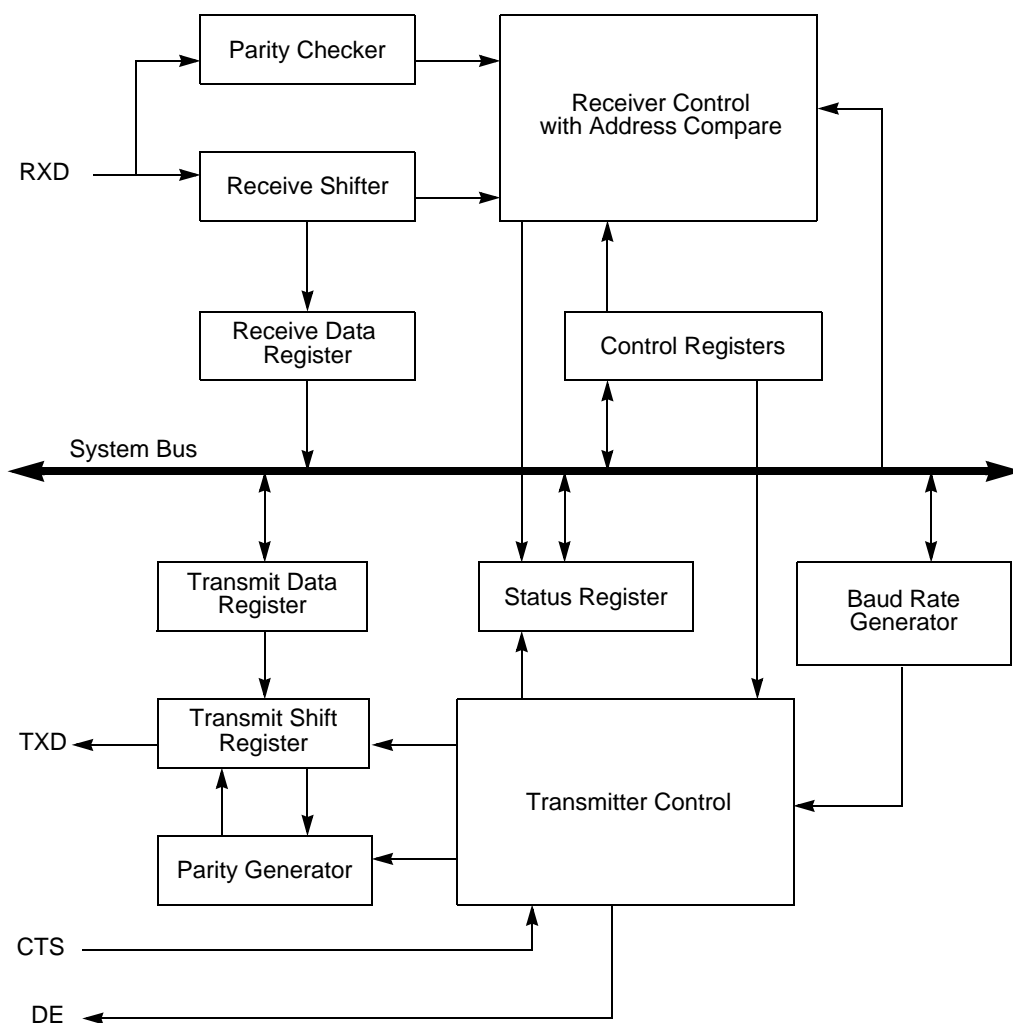## Operation

The UART always transmits and receives data in an 8-bit data format, least-significant bit first. An even or odd parity bit can be added to the data stream. Each character begins with an active Low start bit and ends with either 1 or 2 active High stop bits. Figures 11 and 12 display the asynchronous data format employed by the UART without parity and with parity, respectively.

    – Set or clear the CTSE bit to enable or disable control from the remote receiver using the $\overline{\text{CTS}}$ pin

6. Check the TDRE bit in the UART Status 0 Register to determine if the Transmit Data Register is empty (indicated by a 1). If empty, continue to Step 7. If the Transmit Data Register is full (indicated by a 0), continue to monitor the TDRE bit until the Transmit Data Register becomes available to receive new data.

7. Write the UART Control 1 Register to select the outgoing address bit.

8. Set the Multiprocessor Bit Transmitter (MPBT) if sending an address byte, clear it if sending a data byte.

9. Write the data byte to the UART Transmit Data Register. The transmitter automatically transfers the data to the Transmit Shift Register and transmits the data.

10. Make any changes to the Multiprocessor Bit Transmitter (MPBT) value, if appropriate and MULTIPROCESSOR Mode is enabled.

11. To transmit additional bytes, return to Step 5.

Transmitting Data using the Interrupt-Driven Method

The UART Transmitter interrupt indicates the availability of the Transmit Data Register to accept new data for transmission. Observe the following steps to configure the UART for interrupt-driven data transmission:

1. Write to the UART Baud Rate High and Low Byte registers to set the appropriate baud rate.

2. Enable the UART pin functions by configuring the associated GPIO port pins for alternate function operation.

3. Execute a DI instruction to disable interrupts.

4. Write to the Interrupt control registers to enable the UART Transmitter interrupt and set the acceptable priority.

5. Write to the UART Control 1 Register to enable MULTIPROCESSOR (9-bit) Mode functions, if MULTIPROCESSOR Mode is appropriate.

6. Set the MULTIPROCESSOR Mode Select (MPEN) to Enable MULTIPROCESSOR Mode.

7. Write to the UART Control 0 Register to:
    – Set the transmit enable bit (TEN) to enable the UART for data transmission
    – Enable parity, if appropriate and if MULTIPROCESSOR Mode is not enabled and select either even or odd parity

UART Status 0 Register

The UART Status 0 (UxSTAT0) and Status 1(UxSTAT1) registers, shown in Tables 65 and 66, identify the current UART operating configuration and status.

Table 65. UART Status 0 Register (U0STAT0)

Bit	7	6	5	4	3	2	1	0
Field	RDA	PE	OE	FE	BRKD	TDRE	TXE	CTS
RESET	0	0	0	0	0	1	1	X
R/W	R	R	R	R	R	R	R	R
Address	F41H

Bit	Description
[7] RDA	**Receive Data Available** This bit indicates that the UART Receive Data Register has received data. Reading the UART Receive Data Register clears this bit. 0 = The UART Receive Data Register is empty. 1 = There is a byte in the UART Receive Data Register.
[6] PE	**Parity Error** This bit indicates that a parity error has occurred. Reading the UART Receive Data Register clears this bit. 0 = No parity error has occurred. 1 = A parity error has occurred.
[5] OE	**Overrun Error** This bit indicates that an overrun error has occurred. An overrun occurs when new data is received and the UART Receive Data Register has not been read. If the RDA bit is reset to 0, reading the UART Receive Data Register clears this bit. 0 = No overrun error occurred. 1 = An overrun error occurred.
[4] FE	**Framing Error** This bit indicates that a framing error (no Stop bit following data reception) was detected. Reading the UART Receive Data Register clears this bit. 0 = No framing error occurred. 1 = A framing error occurred.
[3] BRKD	**Break Detect** This bit indicates that a break occurred. If the data bits, parity/multiprocessor bit and Stop bit(s) are all 0s this bit is set to 1. Reading the UART Receive Data Register clears this bit. 0 = No break occurred. 1 = A break occurred.

The ADC registers actually return 13 bits of data, but the two LSBs are intended for compensation use only. When the software compensation routine is performed on the 13 bit raw ADC value, two bits of resolution are lost because of a rounding error. As a result, the final value is an 11-bit number.

Hardware Overflow

When the hardware overflow bit (OVF) is set in ADC Data Low Byte (ADCD_L) Register, all other data bits are invalid. The hardware overflow bit is set for values greater than V_{REF} and less than $-V_{REF}$ (DIFFERENTIAL Mode).

Automatic Powerdown

If the ADC is idle (no conversions in progress) for 160 consecutive system clock cycles, portions of the ADC are automatically powered down. From this powerdown state, the ADC requires 40 system clock cycles to power up. The ADC powers up when a conversion is requested by the ADC Control Register.

Single-Shot Conversion

When configured for single-shot conversion, the ADC performs a single analog-to-digital conversion on the selected analog input channel. After completion of the conversion, the ADC shuts down. Observe the following steps for setting up the ADC and initiating a single-shot conversion:

1. Enable the appropriate analog inputs by configuring the general-purpose I/O pins for alternate analog function. This configuration disables the digital input and output drivers.

2. Write the ADC Control/Status Register 1 to configure the ADC.

   – Write to BUFMODE[2:0] to select SINGLE-ENDED or DIFFERENTIAL mode, plus unbuffered or buffered mode.

   – Write the REFSELH bit of the pair {REFSELH, REFSELL} to select the internal voltage reference level or to disable the internal reference. The REFSELL bit is. contained in the ADC Control Register 0.

3. Write to the ADC Control Register 0 to configure the ADC and begin the conversion. The bit fields in the ADC Control Register can be written simultaneously (the ADC can be configured and enabled with the same write instruction):

   – Write to the ANAIN[3:0] field to select from the available analog input sources (different input pins available depending on the device).

   – Clear CONT to 0 to select a single-shot conversion.

ADC Control Register 0

The ADC Control Register 0 (ADCCTL0) selects the analog input channel and initiates the analog-to-digital conversion. It also selects the voltage reference configuration.

Table 73. ADC Control Register 0 (ADCCTL0)

Bit	7	6	5	4	3	2	1	0
Field	CEN	REFSELL	REFOUT	CONT	ANAIN[3:0]			
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F70H							

Bit	Description
[7] CEN	**Conversion Enable** 0 = Conversion is complete. Writing a 0 produces no effect. The ADC automatically clears this bit to 0 when a conversion is complete. 1 = Begin conversion. Writing a 1 to this bit starts a conversion. If a conversion is already in progress, the conversion restarts. This bit remains 1 until the conversion is complete.
[6] REFSELL	**Voltage Reference Level Select Low Bit** In conjunction with the High bit (REFSELH) in ADC Control/Status Register 1, this determines the level of the internal voltage reference; the following details the effects of {REF-SELH, REFSELL}; note that this reference is independent of the Comparator reference. 00 = Internal Reference Disabled, reference comes from external pin. 01 = Internal Reference set to 1.0 V. 10 = Internal Reference set to 2.0 V (default). 11 = Reserved.
[5] REFOUT	**Internal Reference Output Enable** 0 = Reference buffer is disabled; Vref pin is available for GPIO or analog functions. 1 = The internal ADC reference is buffered and driven out to the V_{REF} pin. **Caution:** When the ADC is used with an external reference ({REFSELH,REFSELL}=00), the REFOUT bit must be set to 0.
[4] CONT	**Conversion** 0 = Single-shot conversion. ADC data is output once at completion of the 5129 system clock cycles (measurements of the internal temperature sensor take twice as long). 1 = Continuous conversion. ADC data updated every 256 system clock cycles after an initial 5129 clock conversion (measurements of the internal temperature sensor take twice as long).
[3:0] ANAIN[3:0]	**Analog Input Select** These bits select the analog input for conversion. Not all Port pins in this list are available in all packages for the Z8 Encore! XP F082A Series. For information about port pins available with each package style, see the Pin Description chapter on page 8. Do not enable unavailable analog inputs. Usage of these bits changes depending on the buffer mode selected in ADC Control/Status Register 1.

Debugger. Writing an invalid value or an invalid sequence returns the Flash Controller to its locked state. The Write-only Flash Control Register shares its Register File address with the read-only Flash Status Register.

Flash Page Select Register

The Flash Page Select (FPS) Register shares address space with the Flash Sector Protect Register. Unless the Flash controller is unlocked and written with 5EH, writes to this address target the Flash Page Select Register.

The register is used to select one of the available Flash memory pages to be programmed or erased. Each Flash Page contains 512 bytes of Flash memory. During a Page Erase operation, all Flash memory having addresses with the most significant 7 bits given by FPS[6:0] are chosen for program/erase operation.

Table 82. Flash Page Select Register (FPS)

Bit	7	6	5	4	3	2	1	0
Field	INFO_EN	PAGE						
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FF9H							

Bit	Description
[7] INFO_EN	**Information Area Enable** 0 = Information Area us not selected. 1 = Information Area is selected. The Information Area is mapped into the Program Memory address space at addresses FE00H through FFFFH.
[6:0] PAGE	**Page Select** This 7-bit field identifies the Flash memory page for Page Erase and page unlocking. Program Memory Address[15:9] = PAGE[6:0]. For the Z8F08xx devices, the upper 3 bits must be zero. For the Z8F04xx devices, the upper 4 bits must be zero. For Z8F02xx devices, the upper 5 bits must always be 0. For the Z8F01xx devices, the upper 6 bits must always be 0.

Table 101. Watchdog Calibration Low Byte at 007FH (WDTCALL)

Bit	7	6	5	4	3	2	1	0
Field	WDTCALL							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Information Page Memory 007FH							
Note: U = Unchanged by Reset. R/W = Read/Write.								

Bit	Description
[7:0] WDTCALL	**Watchdog Timer Calibration Low Byte** The WDTCALH and WDTCALL bytes, when loaded into the Watchdog Timer reload registers result in a one second time-out at room temperature and 3.3V supply voltage. To use the Watchdog Timer calibration, user code must load WDTU with 0x00, WDTH with WDTCALH and WDTL with WDTCALL.

Serialization Data

Table 102. Serial Number at 001C - 001F (S_NUM)

Bit	7	6	5	4	3	2	1	0
Field	S_NUM							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Information Page Memory 001C-001F							
Note: U = Unchanged by Reset. R/W = Read/Write.								

Bit	Description
[7:0] S_NUM	**Serial Number Byte** The serial number is a unique four-byte binary value. See Table 103.

Table 103. Serialization Data Locations

Info Page Address	Memory Address	Usage
1C	FE1C	Serial Number Byte 3 (most significant).
1D	FE1D	Serial Number Byte 2.
1E	FE1E	Serial Number Byte 1.
1F	FE1F	Serial Number Byte 0 (least significant).
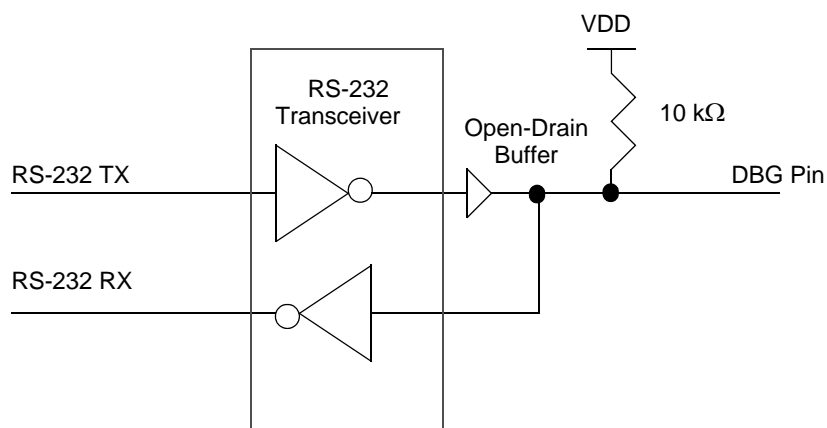
Figure 25. Interfacing the On-Chip Debugger's DBG Pin with an RS-232 Interface; #2 of 2

DEBUG Mode

The operating characteristics of the devices in DEBUG Mode are:

- The eZ8 CPU fetch unit stops, idling the eZ8 CPU, unless directed by the OCD to execute specific instructions

- The system clock operates unless in STOP Mode

- All enabled on-chip peripherals operate unless in STOP Mode

- Automatically exits HALT Mode

- Constantly refreshes the Watchdog Timer, if enabled

Entering DEBUG Mode

The operating characteristics of the devices entering DEBUG Mode are:

- The device enters DEBUG Mode after the eZ8 CPU executes a BRK (Breakpoint) instruction

- If the DBG pin is held Low during the final clock cycle of system reset, the part enters DEBUG Mode immediately (20-/28-pin products only)

> **Note:** Holding the DBG pin Low for an additional 5000 (minimum) clock cycles after reset (making sure to account for any specified frequency error if using an internal oscillator) prevents a false interpretation of an Autobaud sequence (see the OCD Auto-Baud Detector/Generator section on page 183).

When selecting a new clock source, the system clock oscillator failure detection circuitry and the Watchdog Timer oscillator failure circuitry must be disabled. If SOFEN and WOFEN are not disabled prior to a clock switch-over, it is possible to generate an interrupt for a failure of either oscillator. The Failure detection circuitry can be enabled anytime after a successful write of OSCSEL in the OSCCTL Register.

The internal precision oscillator is enabled by default. If the user code changes to a different oscillator, it may be appropriate to disable the IPO for power savings. Disabling the IPO does not occur automatically.

Clock Failure Detection and Recovery

Should an oscillator or timer fail, there are methods of recovery, as this section describes.

System Clock Oscillator Failure

The Z8F04xA family devices can generate nonmaskable interrupt-like events when the primary oscillator fails. To maintain system function in this situation, the clock failure recovery circuitry automatically forces the Watchdog Timer oscillator to drive the system clock. The Watchdog Timer oscillator must be enabled to allow the recovery. Although this oscillator runs at a much slower speed than the original system clock, the CPU continues to operate, allowing execution of a clock failure vector and software routines that either remedy the oscillator failure or issue a failure alert. This automatic switch-over is not available if the Watchdog Timer is selected as the system clock oscillator. It is also unavailable if the Watchdog Timer oscillator is disabled, though it is not necessary to enable the Watchdog Timer reset function (see the Watchdog Timer chapter on page 93).

The primary oscillator failure detection circuitry asserts if the system clock frequency drops below 1kHz ±50%. If an external signal is selected as the system oscillator, it is possible that a very slow but nonfailing clock can generate a failure condition. Under these conditions, do not enable the clock failure circuitry (SOFEN must be deasserted in the OSCCTL Register).

Watchdog Timer Failure

In the event of a Watchdog Timer oscillator failure, a similar nonmaskable interrupt-like event is issued. This event does not trigger an attendant clock switch-over, but alerts the CPU of the failure. After a Watchdog Timer failure, it is no longer possible to detect a primary oscillator failure. The failure detection circuitry does not function if the Watchdog Timer is used as the system clock oscillator or if the Watchdog Timer oscillator has been disabled. For either of these cases, it is necessary to disable the detection circuitry by deasserting the WDFEN bit of the OSCCTL Register.

The Watchdog Timer oscillator failure detection circuit counts system clocks while looking for a Watchdog Timer clock. The logic counts 8004 system clock cycles before determining that a failure has occurred. The system clock rate determines the speed at which

Crystal Oscillator

The products in the Z8 Encore! XP F082A Series contain an on-chip crystal oscillator for use with external crystals with 32 kHz to 20 MHz frequencies. In addition, the oscillator supports external RC networks with oscillation frequencies up to 4 MHz or ceramic resonators with frequencies up to 8 MHz. The on-chip crystal oscillator can be used to generate the primary system clock for the internal eZ8 CPU and the majority of the on-chip peripherals. Alternatively, the X_{IN} input pin can also accept a CMOS-level clock input signal (32 kHz–20 MHz). If an external clock generator is used, the X_{OUT} pin must be left unconnected. The Z8 Encore! XP F082A Series products do not contain an internal clock divider. The frequency of the signal on the X_{IN} input pin determines the frequency of the system clock.

> **Note:** Although the X_{IN} pin can be used as an input for an external clock generator, the CLKIN pin is better suited for such use (see the System Clock Selection section on page 193).

Operating Modes

The Z8 Encore! XP F082A Series products support four oscillator modes:

- Minimum power for use with very low frequency crystals (32 kHz–1 MHz)

- Medium power for use with medium frequency crystals or ceramic resonators (0.5 MHz to 8 MHz)

- Maximum power for use with high frequency crystals (8 MHz to 20 MHz)

- On-chip oscillator configured for use with external RC networks (<4 MHz)

The oscillator mode is selected via user-programmable Flash option bits. See **the** Flash Option Bits chapter on page 159 for information.

Crystal Oscillator Operation

The XTLDIS Flash option bit controls whether the crystal oscillator is enabled during reset. The crystal may later be disabled after reset if a new oscillator has been selected as the system clock. If the crystal is manually enabled after reset through the OSCCTL Register, the user code must wait at least 1000 crystal oscillator cycles for the crystal to stabilize. After this, the crystal oscillator may be selected as the system clock.

Table 128. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	Address Mode src	Opcode(s) (Hex)	Flags C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
LDX dst, src	dst ← src	r	ER	84	–	–	–	–	–	–	3	2
		Ir	ER	85							3	3
		R	IRR	86							3	4
		IR	IRR	87							3	5
		r	X(rr)	88							3	4
		X(rr)	r	89							3	4
		ER	r	94							3	2
		ER	Ir	95							3	3
		IRR	R	96							3	4
		IRR	IR	97							3	5
		ER	ER	E8							4	2
		ER	IM	E9							4	2
LEA dst, X(src)	dst ← src + X	r	X(r)	98	–	–	–	–	–	–	3	3
		rr	X(rr)	99							3	5
MULT dst	dst[15:0] ← dst[15:8] * dst[7:0]	RR		F4	–	–	–	–	–	–	2	8
NOP	No operation			0F	–	–	–	–	–	–	1	2
OR dst, src	dst ← dst OR src	r	r	42	–	*	*	0	–	–	2	3
		r	Ir	43							2	4
		R	R	44							3	3
		R	IR	45							3	4
		R	IM	46							3	3
		IR	IM	47							3	4

Note: Flags Notation:
* = Value is a function of the result of the operation.
– = Unaffected.
X = Undefined.
0 = Reset to 0.
1 = Set to 1.

Lower Nibble (Hex)

Upper Nibble (Hex)

	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0																
1																
2																
3																
4																
5																
6																
7	3 ,															
8																
9																
A			3.3 **CPC** r1,r2	3.4 **CPC** r1,Ir2	4.3 **CPC** R2,R1	4.4 **CPC** IR2,R1	4.3 **CPC** R1,IM	4.4 **CPC** IR1,IM	5.3 **CPCX** ER2,ER1	5.3 **CPCX** IM,ER1						
B																
C	3.2 **SRL** R1	3.3 **SRL** IR1														
D																
E										5, 4 **LDWX** ER2,ER1						
F																

Figure 32. Second Opcode Map after 1FH

Table 131. DC Characteristics (Continued)

Symbol	Parameter	$T_A = -40°C$ to $+105°C$ (unless otherwise specified)			Units	Conditions
		Minimum	Typical	Maximum		
V_{OH1}	High Level Output Voltage	2.4	–	–	V	$I_{OH} = -2$ mA; $V_{DD} = 3.0$ V High Output Drive disabled.
V_{OL2}	Low Level Output Voltage	–	–	0.6	V	$I_{OL} = 20$ mA; $V_{DD} = 3.3$ V High Output Drive enabled.
V_{OH2}	High Level Output Voltage	2.4	–	–	V	$I_{OH} = -20$ mA; $V_{DD} = 3.3$ V High Output Drive enabled.
I_{IH}	Input Leakage Current	–	±0.002	±5	µA	$V_{IN} = V_{DD}$ $V_{DD} = 3.3$ V;
I_{IL}	Input Leakage Current	–	±0.007	±5	µA	$V_{IN} = V_{SS}$ $V_{DD} = 3.3$ V;
I_{TL}	Tristate Leakage Current	–	–	±5	µA	
I_{LED}	Controlled Current Drive	1.8	3	4.5	mA	{AFS2,AFS1} = {0,0}
		2.8	7	10.5	mA	{AFS2,AFS1} = {0,1}
		7.8	13	19.5	mA	{AFS2,AFS1} = {1,0}
		12	20	30	mA	{AFS2,AFS1} = {1,1}
C_{PAD}	GPIO Port Pad Capacitance	–	8.0[2]	–	pF	
C_{XIN}	XIN Pad Capacitance	–	8.0[2]	–	pF	
C_{XOUT}	X_{OUT} Pad Capacitance	–	9.5[2]	–	pF	
I_{PU}	Weak Pull-up Current	30	100	350	µA	$V_{DD} = 3.0$ V–3.6 V
V_{RAM}	RAM Data Retention Voltage	TBD			V	Voltage at which RAM retains static values; no reading or writing is allowed.

Notes:
1. This condition excludes all pins that have on-chip pull-ups, when driven Low.
2. These values are provided for design guidance only and are not tested in production.

On-Chip Peripheral AC and DC Electrical Characteristics

Table 135 tabulates the electrical characteristics of the POR and VBO blocks.

Table 135. Power-On Reset and Voltage Brown-Out Electrical Characteristics and Timing

Symbol	Parameter	T_A = –40°C to +105°C			Units	Conditions
		Minimum	Typical[1]	Maximum		
V_{POR}	Power-On Reset Voltage Threshold	2.20	2.45	2.70	V	$V_{DD} = V_{POR}$
V_{VBO}	Voltage Brown-Out Reset Voltage Threshold	2.15	2.40	2.65	V	$V_{DD} = V_{VBO}$
	V_{POR} to V_{VBO} hysteresis		50	75	mV	
	Starting V_{DD} voltage to ensure valid Power-On Reset.	–	V_{SS}	–	V	
T_{ANA}	Power-On Reset Analog Delay	–	70	–	µs	$V_{DD} > V_{POR}$; T_{POR} Digital Reset delay follows T_{ANA}
T_{POR}	Power-On Reset Digital Delay		16		µs	66 Internal Precision Oscillator cycles + IPO startup time (T_{IPOST})
T_{POR}	Power-On Reset Digital Delay		1		ms	5000 Internal Precision Oscillator cycles
T_{SMR}	Stop Mode Recovery with crystal oscillator disabled		16		µs	66 Internal Precision Oscillator cycles
T_{SMR}	Stop Mode Recovery with crystal oscillator enabled		1		ms	5000 Internal Precision Oscillator cycles
T_{VBO}	Voltage Brown-Out Pulse Rejection Period	–	10	–	µs	Period of time in which $V_{DD} < V_{VBO}$ without generating a Reset.

Note: Data in the typical column is from characterization at 3.3 V and 30°C. These values are provided for design guidance only and are not tested in production.

Table 148. Z8 Encore! XP F082A Series Ordering Matrix

Part Number	Flash	RAM	NVDS	I/O Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Comparator	Temperature Sensor	Description
Z8 Encore! XP F082A Series with 2 KB Flash, 10-Bit Analog-to-Digital Converter											
Standard Temperature: 0°C to 70°C											
Z8F022APB020SG	2 KB	512 B	64 B	6	14	2	4	1	1	1	PDIP 8-pin package
Z8F022AQB020SG	2 KB	512 B	64 B	6	14	2	4	1	1	1	QFN 8-pin package
Z8F022ASB020SG	2 KB	512 B	64 B	6	14	2	4	1	1	1	SOIC 8-pin package
Z8F022ASH020SG	2 KB	512 B	64 B	17	20	2	7	1	1	1	SOIC 20-pin package
Z8F022AHH020SG	2 KB	512 B	64 B	17	20	2	7	1	1	1	SSOP 20-pin package
Z8F022APH020SG	2 KB	512 B	64 B	17	20	2	7	1	1	1	PDIP 20-pin package
Z8F022ASJ020SG	2 KB	512 B	64 B	23	20	2	8	1	1	1	SOIC 28-pin package
Z8F022AHJ020SG	2 KB	512 B	64 B	23	20	2	8	1	1	1	SSOP 28-pin package
Z8F022APJ020SG	2 KB	512 B	64 B	23	20	2	8	1	1	1	PDIP 28-pin package
Extended Temperature: –40°C to 105°C											
Z8F022APB020EG	2 KB	512 B	64 B	6	14	2	4	1	1	1	PDIP 8-pin package
Z8F022AQB020EG	2 KB	512 B	64 B	6	14	2	4	1	1	1	QFN 8-pin package
Z8F022ASB020EG	2 KB	512 B	64 B	6	14	2	4	1	1	1	SOIC 8-pin package
Z8F022ASH020EG	2 KB	512 B	64 B	17	20	2	7	1	1	1	SOIC 20-pin package
Z8F022AHH020EG	2 KB	512 B	64 B	17	20	2	7	1	1	1	SSOP 20-pin package
Z8F022APH020EG	2 KB	512 B	64 B	17	20	2	7	1	1	1	PDIP 20-pin package
Z8F022ASJ020EG	2 KB	512 B	64 B	23	20	2	8	1	1	1	SOIC 28-pin package
Z8F022AHJ020EG	2 KB	512 B	64 B	23	20	2	8	1	1	1	SSOP 28-pin package
Z8F022APJ020EG	2 KB	512 B	64 B	23	20	2	8	1	1	1	PDIP 28-pin package